Lattice Semiconductor Corporation - LFSC3GA115E-6FF1152I Datasheet

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

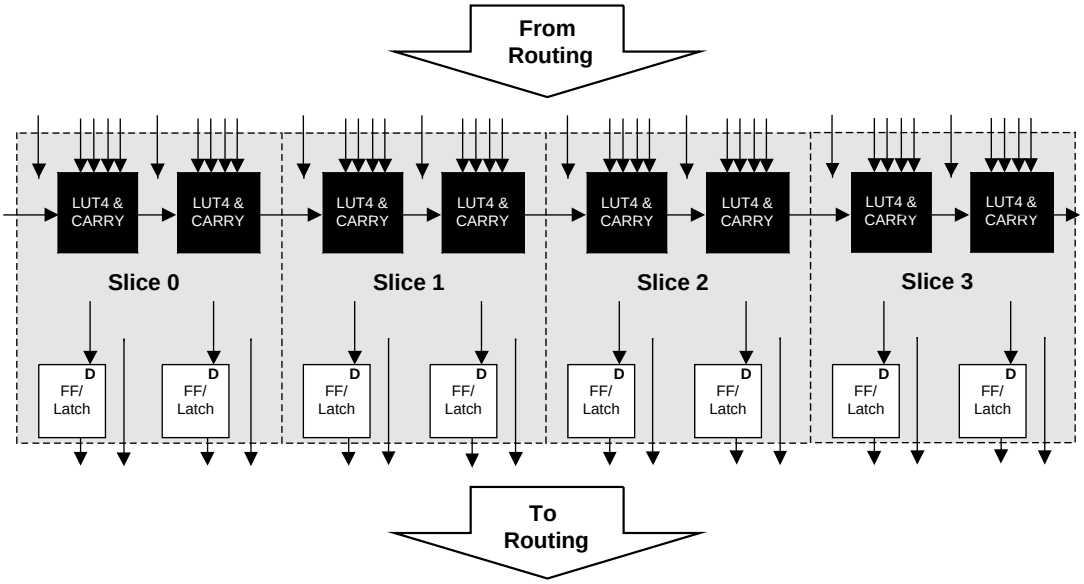
Details	
Product Status	Obsolete
Number of LABs/CLBs	28750
Number of Logic Elements/Cells	115000
Total RAM Bits	7987200
Number of I/O	660
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 105°C (TJ)
Package / Case	1152-BBGA, FCBGA
Supplier Device Package	1152-FCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfsc3ga115e-6ff1152i

PFU Blocks

The core of the LatticeSC devices consists of PFU blocks. The PFUs can be programmed to perform Logic, Arithmetic, Distributed RAM and Distributed ROM functions.

Each PFU block consists of four interconnected slices, numbered 0-3 as shown in Figure 2-2. All the interconnections to and from PFU blocks are from routing. There are 53 inputs and 25 outputs associated with each PFU block.

Figure 2-2. PFU Diagram



Slice

Each slice contains two LUT4 lookup tables feeding two registers (programmed to be in FF or Latch mode), and some associated logic that allows the LUTs to be combined to implement 5, 6, 7 and 8 Input LUTs (LUT5, LUT6, LUT7 and LUT8). There is control logic to perform set/reset functions (programmable as synchronous/asynchronous), clock select, chip-select and wider RAM/ROM functions. Figure 2-3 shows an overview of the internal logic of the slice. The registers in the slice can be configured for positive/negative and edge/level clocks.

There are 14 input signals: 13 signals from routing and one from the carry-chain (from adjacent slice or PFU). There are seven outputs: six to routing and one to carry-chain (to adjacent PFU). Table 2-1 lists the signals associated with each slice.

Figure 2-27. Output Termination Schemes

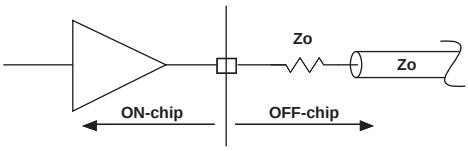
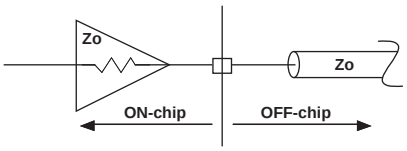
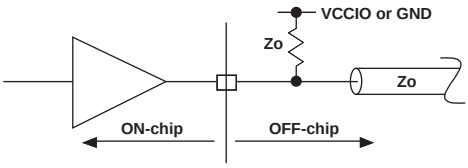
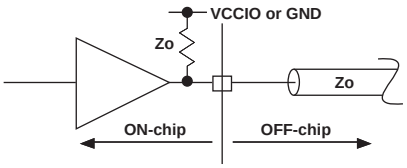
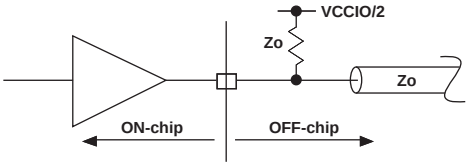
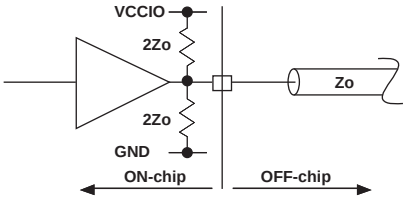
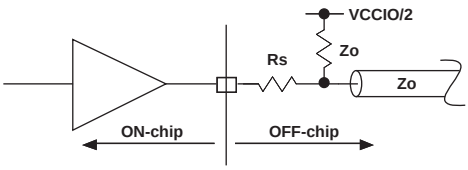
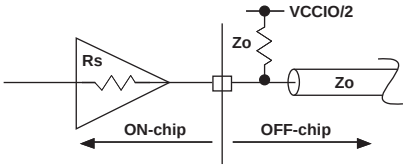
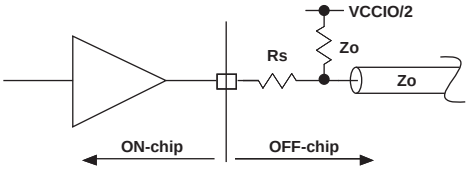
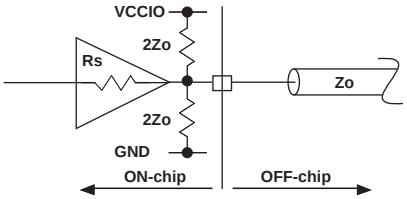
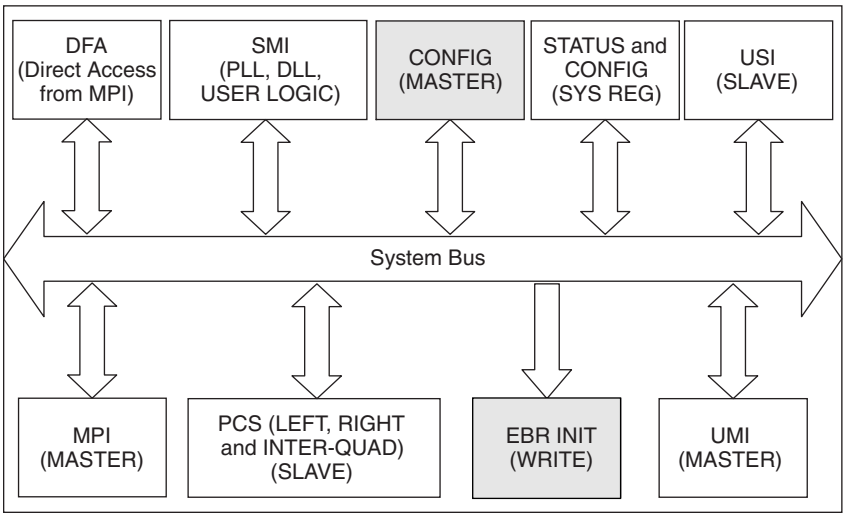
Termination Type	Discrete Off-Chip Solution	Lattice On-Chip Solution
Series termination (controlled output impedance)		
Parallel termination to V_{CCIO}, or parallel driving end		
Parallel termination to $V_{CCIO}/2$ driving end		
Combined series + parallel termination to $V_{CCIO}/2$ at driving end (only series termination moved on-chip)		
Combined series + parallel to $V_{CCIO}/2$ driving end		

Figure 2-31. LatticeSC System Bus Interfaces



Several interfaces exist between the System Bus and other FPGA elements. The MPI interface acts as a bridge between the external microprocessor bus and System Bus. The MPI may work in an independent clock domain from the System Bus if the System Bus clock is not sourced from the external microprocessor clock. Pipelined operation allows high-speed memory interface to the EBR and peripheral access without the requirement for additional cycles on the bus. Burst transfers allow optimal use of the memory interface by giving advance information of the nature of the transfers.

Details for the majority of the peripherals can be found in the associated technical documentation, see details at the end of this data sheet. Additional details of the MPI are provided below.

Microprocessor Interface (MPI)

The LatticeSC family devices have a dedicated synchronous MPI function block. The MPI is programmable to operate with PowerPC/PowerQUICC MPC860/MPC8260 series microprocessors. The MPI implements an 8-, 16-, or 32-bit interface with 1-bit, 2-bit, or 4-bit parity to the host processor (PowerPC) that can be used for configuration and read-back of the FPGA as well as for user-defined data processing and general monitoring of FPGA functions.

The control portion of the MPI is available following power-up of the FPGA if the mode pins specify MPI mode, even if the FPGA is not yet configured. The width of the data port is selectable among 8-, 16-, or 32-bit and the parity bus can be 1-, 2-, or 4-bit. In configuration mode the data and parity bus width are related to the state of the M[0:3] mode pins. For post-configuration use, the MPI must be included in the configuration bit stream by using an MPI library element in your design from the ispLEVER primitive library, or by setting the bit of the MPI configuration control register prior to the start of configuration. The user can also enable and disable the parity bus through the configuration bit stream. These pads can be used as general I/O when they are not needed for MPI use.

The MPI block also provides the capability to interface directly to the FPGA fabric with a databus after configuration.The bus protocol is still handled by the MPI block but the direct FPGA access allows high-speed block data transfers such as DMA transactions. Figure 2-32 shows one of the ways a PowerPC is connected to MPI.

Power Supply Ramp Rates

Symbol	Parameter	Condition	Min.	Typ.	Max	Units
t_{RAMP}	Power supply ramp rates for all power supplies	Over process, voltage, temperature	3.45	—	—	mV/µs
			—	—	75	ms

1. See the Power-up and Power-Down requirements section for more details on power sequencing.
2. From 0.5V to minimum operating voltage.

Hot Socketing Specifications[1]

Symbol	Parameter	Condition	Min.	Typ.	Max	Units
I_{DK}	Programmable and dedicated Input or I/O leakage current[2, 3, 4, 5, 6]	0 <= V_{IN} <= V_{IH} (MAX)	—	—	±1500	µA
I_{HDIN}	SERDES average input current when device powered down and inputs driven[7]		—	—	4	mA

1. See Hot Socket power up/down information in Chapter 2 of this document.
2. Assumes monotonic rise/fall rates for all power supplies.
3. Sensitive to power supply sequencing as described in hot socketing section.
4. Assumes power supplies are between 0 and maximum recommended operations conditions.
5. IDK is additive to I_{PU}, I_{PD} or I_{BH}.
6. Represents DC conditions. For the first 20ns after hot insertion, current specification is 8 mA.
7. Assumes that the device is powered down with all supplies grounded, both P and N inputs driven by a CML driver with maximum allowed VDDOB of 1.575V, 8b/10b data and internal AC coupling.

DC Electrical Characteristics[5]

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.[3]	Typ.	Max.	Units
I_{IL}, I_{IH}[1]	Input or I/O Low leakage	0 ≤ V_{IN} ≤ V_{IH} (MAX)	—	—	10	µA
I_{PU}	I/O Active Pull-up Current	0 ≤ V_{IN} ≤ 0.7 V_{CCIO}	-30	—	-210	µA
I_{PD}	I/O Active Pull-down Current	V_{IL} (MAX) ≤ V_{IN} ≤ V_{IH} (MAX)	30	—	210	µA
I_{BHLS}	Bus Hold Low Sustaining Current	V_{IN} = V_{IL} (MAX)	30	—	—	µA
I_{BHHS}	Bus Hold High Sustaining Current	V_{IN} = 0.7V_{CCIO}	-30	—	—	µA
I_{BHLO}	Bus Hold Low Overdrive Current	0 ≤ V_{IN} ≤ V_{IH} (MAX)	—	—	210	µA
I_{BHLH}	Bus Hold High Overdrive Current	0 ≤ V_{IN} ≤ V_{IH} (MAX)	—	—	-210	µA
I_{CL}	PCI Low Clamp Current	-3 < V_{IN} ≤ -1	-25 + (V_{IN} + 1)/0.015	—	—	mA
I_{CH}	PCI High Clamp Current	V_{CC} + 4 > V_{IN} ≥ V_{CC} + 1	25 + (V_{IN} - V_{CC} -1)/ 0.015	—	—	mA
V_{BHT}	Bus Hold trip Points	0 ≤ V_{IN} ≤ V_{IH} (MAX)	V_{IL} (MAX)	—	V_{IH} (MIN)	V
C1	I/O Capacitance[2]	V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V, V_{CC} = 1.2V, V_{CCIP2} = 1.2V, V_{CCAUX} = 2.5, V_{IO} = 0 to V_{IH} (MAX)	—	8	—	pf
C3[2]	Dedicated Input Capacitance[2]	V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V, V_{CC} = 1.2V, V_{CCIP2} = 1.2V, V_{CCAUX} = 2.5, V_{IO} = 0 to V_{IH} (MAX)	—	6	—	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.
2. T_A 25°C, f = 1.0MHz
3. I_{PU}, I_{PD}, I_{BHLS} and I_{BHHS} have minimum values of 15 or -15µA if V_{CCIO} is set to 1.2V nominal.
4. This table does not apply to SERDES pins.
5. For programmable I/Os.

PURESPEED I/O Differential Electrical Characteristics

LVDS

Over Recommended Operating Conditions

Parameter Symbol	Parameter Description	Test Conditions	Min.	Typ.	Max.	Units
V_{INP}, V_{INM}	Input voltage		0	—	2.4	V
V_{THD}	Differential input threshold (Q-$\overline{Q}$)		+/-100	—	—	mV
V_{CM}	Input common mode voltage		0.05	1.2	2.35	V
I_{IN}	Input current	Power on or power off	—	—	+/-10	µA
V_{OH}	Output high voltage for V_{OP} or V_{OM}	R_T = 100 Ohm	—	1.38	1.60	V
V_{OL}	Output low voltage for V_{OP} or V_{OM}	R_T = 100 Ohm	0.9V	1.03	—	V
V_{OD}	Output voltage differential	(V_{OP} - V_{OM}), R_T = 100 Ohm	250	350	450	mV
ΔV_{OD}	Change in V_{OD} between high and low		—	—	50	mV
V_{OS}	Output voltage offset	(V_{OP} - V_{OM})/2, R_T = 100 Ohm	1.125	1.20	1.375	V
ΔV_{OS}	Change in V_{OS} between H and L		—	—	50	mV
I_{SAB}	Output short circuit current	V_{OD} = 0V Driver outputs shorted	—	—	12	mA
T_R, T_F	Output rise and fall times, 20% to 80%	—	—	500	ps	T_R, T_F

Notes:
1. Data is for 3.5mA differential current drive. Other differential driver current options are available.
2. If the low power mode of the input buffer is used, the minimum V_{CM} is 600 mV.

Mini-LVDS

Over Recommended Operating Conditions

Parameter Symbol	Description	Min.	Typ.	Max.	Units
Z_O	Single-ended PCB trace impedance	30	50	75	ohms
R_T	Differential termination resistance	60	100	150	ohms
V_{OD}	Output voltage, differential, $\|V_{OP} - V_{OM}\|$	300	—	600	mV
V_{OS}	Output voltage, common mode, $\|V_{OP} + V_{OM}\|/2$	1	1.2	1.4	V
ΔV_{OD}	Change in V_{OD}, between H and L	—	—	50	mV
ΔV_{ID}	Change in V_{OS}, between H and L	—	—	50	mV
V_{THD}	Input voltage, differential, $\|V_{INP} - V_{INM}\|$	200	—	600	mV
V_{CM}	Input voltage, common mode, $\|V_{INP} + V_{INM}\|/2$	0.3+(V_{THD}/2)	—	2.1-(V_{THD}/2)	
T_R, T_F	Output rise and fall times, 20% to 80%	—	—	500	ps
T_{ODUTY}	Output clock duty cycle	45	—	55	%
T_{IDUTY}	Input clock duty cycle	40	—	60	%

Note: Data is for 6mA differential current drive. Other differential driver current options are available.

Switching Test Conditions

Figure 3-15 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 3-4.

Figure 3-15. Output Test Load, LVTTL and LVCMOS Standards

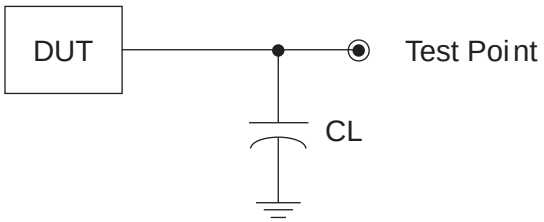


Table 3-4. Test Fixture Required Components, Non-Terminated Interfaces

Test Condition	C_L	Timing Ref.	V_T
LVTTL and other LVCMOS settings (L -> H, H -> L)	30pF	LVCMOS 3.3 = 1.5V	—
		LVCMOS 2.5 = $V_{CCIO}/2$	—
		LVCMOS 1.8 = $V_{CCIO}/2$	—
		LVCMOS 1.5 = $V_{CCIO}/2$	—
		LVCMOS 1.2 = $V_{CCIO}/2$	—
LVCMOS 2.5 I/O (Z -> H)	30pF	$V_{CCIO}/2$	V_{OL}
LVCMOS 2.5 I/O (Z -> L)		$V_{CCIO}/2$	V_{OH}
LVCMOS 2.5 I/O (H -> Z)		V_{OH} - 0.15	V_{OL}
LVCMOS 2.5 I/O (L -> Z)		V_{OL} + 0.15	V_{OH}

Note: Output test conditions for all other interfaces are determined by the respective standards.

LFSC/M15 Logic Signal Connections: 256 fpBGA[1,2] (Cont.)

Ball Number	LFSC/M15		
	Ball Function	VCCIO Bank	Dual Function
F14	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D
E15	PR15B	2	URC_PLLC_IN_A/URC_PLLC_FB_B
E14	PR15A	2	URC_PLLT_IN_A/URC_PLLT_FB_B
D9	VCCJ	-	
C16	TDO	-	TDO
B15	TMS	-	
B16	TCK	-	
E13	TDI	-	
C14	PROGRAMN	1	
C15	CCLK	1	
A15	PT43D	1	HDC/SI
A14	PT43C	1	LDCN/SCS
B14	PT41A	1	CS1
E12	PT39B	1	CS0N
D13	PT39A	1	RDN
D12	PT37D	1	WRN
E10	PT37C	1	D7
C11	PT37B	1	D6
D10	PT37A	1	D5
A13	PT36D	1	D4
B12	PT36C	1	D3
A12	PT35B	1	D2
C12	PT35A	1	D1
A11	PT33B	1	D0
B11	PT33A	1	QOUT/CEON
E9	PT32D	1	VREF2_1
E8	PT32B	1	DOUT
D8	PT28C	1	BUSYN/RCLK/SCK
A10	PT27B	1	PCLKC1_0
C10	PT27A	1	PCLKT1_0
E7	PT21C	1	VREF1_1
C9	A_VDDIB3_L	-	
A9	A_HDINP3_L	-	PCS 360 CH 3 IN P
B9	A_HDINN3_L	-	PCS 360 CH 3 IN N
A8	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
B8	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
C8	A_VDDOB3_L	-	
B7	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
C7	A_VDDOB2_L	-	
A7	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
B6	A_HDINN2_L	-	PCS 360 CH 2 IN N
A6	A_HDINP2_L	-	PCS 360 CH 2 IN P
C6	A_VDDIB2_L	-	

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA[1, 2] (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
D14	PT15B	1	A15/MPI_ADDR29	PT25B	1	A15/MPI_ADDR29
D13	PT15A	1	A17/MPI_ADDR31	PT25A	1	A17/MPI_ADDR31
F12	PT13D	1	A19/MPI_TSIZ1	PT24D	1	A19/MPI_TSIZ1
F13	PT13C	1	A20/MPI_BDIP	PT24C	1	A20/MPI_BDIP
B12	PT11B	1	A18/MPI_TSIZ0	PT24B	1	A18/MPI_TSIZ0
B11	PT11A	1	MPI_TEA	PT24A	1	MPI_TEA
E12	PT10D	1	D14/MPI_DATA14	PT23D	1	D14/MPI_DATA14
D12	PT10C	1	DP1/MPI_PAR1	PT23C	1	DP1/MPI_PAR1
G10	PT9B	1	A21/MPI_BURST	PT23B	1	A21/MPI_BURST
G9	PT9A	1	D15/MPI_DATA15	PT23A	1	D15/MPI_DATA15
C10	A_VDDIB3_L	-		A_VDDIB3_L	-	
E9	VCC12	-		VCC12	-	
B10	A_HDINP3_L	-	PCS 360 CH 3 IN P	A_HDINP3_L	-	PCS 360 CH 3 IN P
B9	A_HDINN3_L	-	PCS 360 CH 3 IN N	A_HDINN3_L	-	PCS 360 CH 3 IN N
A10	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
D9	VCC12	-		VCC12	-	
A9	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
C9	A_VDDOB3_L	-		A_VDDOB3_L	-	
A8	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
C8	A_VDDOB2_L	-		A_VDDOB2_L	-	
A7	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
E8	VCC12	-		VCC12	-	
B8	A_HDINN2_L	-	PCS 360 CH 2 IN N	A_HDINN2_L	-	PCS 360 CH 2 IN N
B7	A_HDINP2_L	-	PCS 360 CH 2 IN P	A_HDINP2_L	-	PCS 360 CH 2 IN P
C7	A_VDDIB2_L	-		A_VDDIB2_L	-	
D8	VCC12	-		VCC12	-	
C6	A_VDDIB1_L	-		A_VDDIB1_L	-	
E7	VCC12	-		VCC12	-	
B6	A_HDINP1_L	-	PCS 360 CH 1 IN P	A_HDINP1_L	-	PCS 360 CH 1 IN P
B5	A_HDINN1_L	-	PCS 360 CH 1 IN N	A_HDINN1_L	-	PCS 360 CH 1 IN N
A6	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
D7	VCC12	-		VCC12	-	
A5	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
C5	A_VDDOB1_L	-		A_VDDOB1_L	-	
A4	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N
C4	A_VDDOB0_L	-		A_VDDOB0_L	-	
A3	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P
E6	VCC12	-		VCC12	-	
B4	A_HDINN0_L	-	PCS 360 CH 0 IN N	A_HDINN0_L	-	PCS 360 CH 0 IN N
B3	A_HDINP0_L	-	PCS 360 CH 0 IN P	A_HDINP0_L	-	PCS 360 CH 0 IN P
C3	A_VDDIB0_L	-		A_VDDIB0_L	-	
D6	VCC12	-		VCC12	-	
L5	NC	-		PL21A	7	
M5	NC	-		PL21B	7	
G2	NC	-		PL20A	7	

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA[1, 2] (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AH20	NC	-		PB51D	4	
AK27	NC	-		NC	-	
AJ24	NC	-		NC	-	
AF17	NC	-		PB42C	4	
AH27	NC	-		PB61B	4	
AD23	NC	-		PB57A	4	
AE23	NC	-		PB57B	4	
AH24	NC	-		PB59A	4	
AH25	NC	-		PB59B	4	
AH26	NC	-		PB61A	4	
AF24	NC	-		PB63A	4	
AG24	NC	-		PB63B	4	
AG25	NC	-		PB64A	4	
AF25	NC	-		PB64B	4	
AG26	NC	-		PB65A	4	
AF27	NC	-		PB65B	4	
AD28	NC	-		PR56B	3	
AC27	NC	-		PR56A	3	
AE29	NC	-		PR53B	3	
AD29	NC	-		PR53A	3	
AB30	NC	-		NC	-	
AA28	NC	-		NC	-	
Y27	NC	-		PR47C	3	
W27	NC	-		PR47D	3	
V30	NC	-		PR47A	3	
W30	NC	-		PR47B	3	
W26	NC	-		PR43D	3	
V26	NC	-		PR43C	3	
U25	NC	-		PR42C	3	
T27	NC	-		PR40B	3	
R27	NC	-		PR40A	3	
V27	NC	-		PR39B	3	
U27	NC	-		PR39A	3	
U29	NC	-		PR36B	3	
T29	NC	-		PR36A	3	
T24	NC	-		PR35C	3	
Y25	NC	-		PR48C	3	
P24	NC	-		NC	-	
K28	NC	-		NC	-	
P23	NC	-		NC	-	
L28	NC	-		NC	-	
M27	NC	-		PR21B	2	
L27	NC	-		PR21A	2	
H27	NC	-		PR20B	2	
G27	NC	-		PR20A	2	

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA[1, 2] (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
B29	NC	-		NC	-	

1. Differential pair grouping within a PIC is A (True) and B (Complement) and C (True) and D (Complement).
2. The LatticeSC/M15 and LatticeSC/M25 in a 900-pin package supports a 16-bit MPI interface.

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
H1	PR25B	2		PR23B	2	
H2	PR25A	2		PR23A	2	
N8	PR22D	2		PR25D	2	
M8	PR22C	2		PR25C	2	
H4	PR22B	2		PR25B	2	
J4	PR22A	2		PR25A	2	
G1	PR21B	2		PR22B	2	
G2	PR21A	2		PR22A	2	
L7	PR20D	2		PR21D	2	
L8	PR20C	2		PR21C	2	
F2	PR20B	2		PR21B	2	
F1	PR20A	2		PR21A	2	
K5	PR18D	2	VREF2_2	PR18D	2	VREF2_2
J5	PR18C	2		PR18C	2	
E2	PR18B	2	URC_DLLC_IN_D/URC_DLLC_FB_C	PR18B	2	URC_DLLC_IN_D/URC_DLLC_FB_C
E1	PR18A	2	URC_DLLT_IN_D/URC_DLLT_FB_C	PR18A	2	URC_DLLT_IN_D/URC_DLLT_FB_C
N10	PR17D	2	URC_PLLC_IN_B/URC_PLLC_FB_A	PR17D	2	URC_PLLC_IN_B/URC_PLLC_FB_A
M10	PR17C	2	URC_PLLT_IN_B/URC_PLLT_FB_A	PR17C	2	URC_PLLT_IN_B/URC_PLLT_FB_A
D2	PR17B	2	URC_DLLC_IN_C/URC_DLLC_FB_D	PR17B	2	URC_DLLC_IN_C/URC_DLLC_FB_D
D1	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D
K6	PR16D	2		PR16D	2	
K7	PR16C	2		PR16C	2	
J8	PR16B	2	URC_PLLC_IN_A/URC_PLLC_FB_B	PR16B	2	URC_PLLC_IN_A/URC_PLLC_FB_B
K8	PR16A	2	URC_PLLT_IN_A/URC_PLLT_FB_B	PR16A	2	URC_PLLT_IN_A/URC_PLLT_FB_B
J10	VCCJ	-		VCCJ	-	
J9	TDO	-	TDO	TDO	-	TDO
K9	TMS	-		TMS	-	
J12	TCK	-		TCK	-	
J13	TDI	-		TDI	-	
K12	PROGRAMN	1		PROGRAMN	1	
K13	MPIIRQN	1	CFGIRQN/MPI_IRQ_N	MPIIRQN	1	CFGIRQN/MPI_IRQ_N
K10	CCLK	1		CCLK	1	
F5	RESP_URC	-		RESP_URC	-	
B5	VCC12	-		VCC12	-	
D5	A_REFCLKN_R	-		A_REFCLKN_R	-	
C5	A_REFCLKP_R	-		A_REFCLKP_R	-	
B2	A_VDDIB0_R	-		A_VDDIB0_R	-	
C1	A_HDINP0_R	-	PCS 3E0 CH 0 IN P	A_HDINP0_R	-	PCS 3E0 CH 0 IN P
C2	A_HDINN0_R	-	PCS 3E0 CH 0 IN N	A_HDINN0_R	-	PCS 3E0 CH 0 IN N
A3	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P
D3	A_VDDOB0_R	-		A_VDDOB0_R	-	
B3	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N
D4	A_VDDOB1_R	-		A_VDDOB1_R	-	
B4	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N
A4	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P
H5	A_HDINN1_R	-	PCS 3E0 CH 1 IN N	A_HDINN1_R	-	PCS 3E0 CH 1 IN N
G5	A_HDINP1_R	-	PCS 3E0 CH 1 IN P	A_HDINP1_R	-	PCS 3E0 CH 1 IN P
F4	A_VDDIB1_R	-		A_VDDIB1_R	-	
H6	A_VDDIB2_R	-		A_VDDIB2_R	-	
F6	A_HDINP2_R	-	PCS 3E0 CH 2 IN P	A_HDINP2_R	-	PCS 3E0 CH 2 IN P

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AF21	PB26D	5		PB29D	5	
AN23	PB27A	5		PB45A	5	
AN22	PB27B	5		PB45B	5	
AP23	PB29A	5		PB55A	5	
AP22	PB29B	5		PB55B	5	
AG21	PB29C	5		PB55C	5	
AG20	PB29D	5		PB55D	5	
AP25	PB30A	5	PCLKT5_3	PB48A	5	PCLKT5_3
AP24	PB30B	5	PCLKC5_3	PB48B	5	PCLKC5_3
AD21	PB30C	5	PCLKT5_4	PB48C	5	PCLKT5_4
AD20	PB30D	5	PCLKC5_4	PB48D	5	PCLKC5_4
AL23	PB31A	5	PCLKT5_5	PB49A	5	PCLKT5_5
AL22	PB31B	5	PCLKC5_5	PB49B	5	PCLKC5_5
AH24	PB31C	5		PB49C	5	
AH23	PB31D	5		PB49D	5	
AM23	PB33A	5	PCLKT5_0	PB51A	5	PCLKT5_0
AM22	PB33B	5	PCLKC5_0	PB51B	5	PCLKC5_0
AJ24	PB33C	5		PB51C	5	
AJ23	PB33D	5	VREF2_5	PB51D	5	VREF2_5
AN21	PB34A	5	PCLKT5_1	PB52A	5	PCLKT5_1
AN20	PB34B	5	PCLKC5_1	PB52B	5	PCLKC5_1
AE19	PB34C	5	PCLKT5_6	PB52C	5	PCLKT5_6
AD19	PB34D	5	PCLKC5_6	PB52D	5	PCLKC5_6
AK21	PB35A	5	PCLKT5_2	PB53A	5	PCLKT5_2
AK20	PB35B	5	PCLKC5_2	PB53B	5	PCLKC5_2
AK23	PB35C	5	PCLKT5_7	PB53C	5	PCLKT5_7
AK22	PB35D	5	PCLKC5_7	PB53D	5	PCLKC5_7
AL20	PB37A	5		PB56A	5	
AL19	PB37B	5		PB56B	5	
AG19	PB37C	5		PB56C	5	
AF19	PB37D	5		PB56D	5	
AP21	PB38A	5		PB57A	5	
AP20	PB38B	5		PB57B	5	
AH21	PB38C	5		PB57C	5	
AH20	PB38D	5		PB57D	5	
AM20	PB39A	5		PB59A	5	
AM19	PB39B	5		PB59B	5	
AJ21	PB39C	5		PB59C	5	
AJ20	PB39D	5		PB59D	5	
AK19	PB41A	5		PB60A	5	
AK18	PB41B	5		PB60B	5	
AE18	PB41C	5		PB60C	5	
AD18	PB41D	5		PB60D	5	
AN19	PB42A	5		PB61A	5	
AN18	PB42B	5		PB61B	5	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
C32	VCC12	-		VCC12	-	
E34	NC	-		PL22A	7	
F34	NC	-		PL22B	7	
F33	NC	-		PL24A	7	
G33	NC	-		PL24B	7	
K30	NC	-		PL25A	7	
L30	NC	-		PL25B	7	
G34	NC	-		PL26A	7	
H34	NC	-		PL26B	7	
M32	NC	-		PL39A	7	
N32	NC	-		PL39B	7	
P28	NC	-		PL39C	7	
R28	NC	-		PL39D	7	
J34	NC	-		PL41A	7	
K34	NC	-		PL41B	7	
P30	NC	-		PL41C	7	
R30	NC	-		PL41D	7	
W34	NC	-		PL59A	6	
Y34	NC	-		PL59B	6	
W32	NC	-		PL61A	6	
Y32	NC	-		PL61B	6	
AA34	NC	-		PL64A	6	
AB34	NC	-		PL64B	6	
AC34	NC	-		PL67A	6	
AD34	NC	-		PL67B	6	
Y30	NC	-		PL68A	6	
AA30	NC	-		PL68B	6	
AB33	NC	-		PL69A	6	
AC33	NC	-		PL69B	6	
AC2	NC	-		PR69B	3	
AB2	NC	-		PR69A	3	
AA5	NC	-		PR68B	3	
Y5	NC	-		PR68A	3	
AD1	NC	-		PR67B	3	
AC1	NC	-		PR67A	3	
AB1	NC	-		PR64B	3	
AA1	NC	-		PR64A	3	
Y3	NC	-		PR61B	3	
W3	NC	-		PR61A	3	
Y1	NC	-		PR59B	3	
W1	NC	-		PR59A	3	
R5	NC	-		PR41D	2	
P5	NC	-		PR41C	2	
K1	NC	-		PR41B	2	
J1	NC	-		PR41A	2	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AN15	PB89A	4	PCLKT4_2
AN14	PB89B	4	PCLKC4_2
AE16	PB89C	4	PCLKT4_7
AD16	PB89D	4	PCLKC4_7
AK15	PB90A	4	PCLKT4_1
AK14	PB90B	4	PCLKC4_1
AG15	PB90C	4	PCLKT4_6
AG14	PB90D	4	PCLKC4_6
AM13	PB91A	4	PCLKT4_0
AM12	PB91B	4	PCLKC4_0
AJ12	PB91C	4	VREF2_4
AJ11	PB91D	4	
AL13	PB93A	4	PCLKT4_5
AL12	PB93B	4	PCLKC4_5
AH12	PB93C	4	
AH11	PB93D	4	
AN13	PB94A	4	PCLKT4_3
AN12	PB94B	4	PCLKC4_3
AD14	PB94C	4	PCLKT4_4
AD15	PB94D	4	PCLKC4_4
AP13	PB87A	4	
AP12	PB87B	4	
AK13	PB87C	4	
AK12	PB87D	4	
AP11	PB97A	4	
AP10	PB97B	4	
AN11	PB113A	4	
AN10	PB113B	4	
AF14	PB113C	4	
AF13	PB113D	4	
AM10	PB115A	4	
AM9	PB115B	4	
AE14	PB115C	4	
AE13	PB115D	4	
AP9	PB118A	4	
AP8	PB118B	4	
AK11	PB118C	4	
AK10	PB118D	4	
AL10	PB121A	4	
AL9	PB121B	4	
AF12	PB121C	4	
AF11	PB121D	4	
AN9	PB123A	4	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AD33	PL59D	6		PL73D	6	
AA38	PL60A	6		PL74A	6	
AB38	PL60B	6		PL74B	6	
AC29	PL60C	6		PL74C	6	
AD29	PL60D	6		PL74D	6	
AA41	PL61A	6		PL75A	6	
AB41	PL61B	6		PL75B	6	
AC34	PL61C	6		PL75C	6	
AD34	PL61D	6		PL75D	6	
AA42	PL63A	6		PL77A	6	
AB42	PL63B	6		PL77B	6	
AC37	PL63C	6		PL77C	6	
AD37	PL63D	6		PL77D	6	
AC38	PL64A	6		PL78A	6	
AD38	PL64B	6		PL78B	6	
AD36	PL64C	6		PL78C	6	
AE36	PL64D	6		PL78D	6	
AC39	PL65A	6		PL79A	6	
AD39	PL65B	6		PL79B	6	
AD35	PL65C	6		PL79C	6	
AE35	PL65D	6		PL79D	6	
AC40	PL67A	6		PL81A	6	
AD40	PL67B	6		PL81B	6	
AE37	PL67C	6		PL81C	6	
AF37	PL67D	6		PL81D	6	
AC41	PL68A	6		PL82A	6	
AD41	PL68B	6		PL82B	6	
AE34	PL68C	6		PL82C	6	
AF34	PL68D	6		PL82D	6	
AC42	PL69A	6		PL83A	6	
AD42	PL69B	6		PL83B	6	
AE33	PL69C	6		PL83C	6	
AF33	PL69D	6		PL83D	6	
AE38	PL72A	6		PL86A	6	
AF38	PL72B	6		PL86B	6	
AE32	PL72C	6		PL86C	6	
AF32	PL72D	6		PL86D	6	
AE41	PL73A	6		PL87A	6	
AF41	PL73B	6		PL87B	6	
AE31	PL73C	6		PL87C	6	
AF31	PL73D	6		PL87D	6	
AE42	PL74A	6		PL88A	6	
AF42	PL74B	6		PL88B	6	
AG37	PL74C	6		PL88C	6	
AH37	PL74D	6		PL88D	6	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AF40	PL76A	6		PL90A	6	
AG40	PL76B	6		PL90B	6	
AG36	PL76C	6		PL90C	6	
AH36	PL76D	6	DIFFR_6	PL90D	6	DIFFR_6
AF39	PL77A	6		PL91A	6	
AG39	PL77B	6		PL91B	6	
AF29	PL77C	6		PL91C	6	
AG29	PL77D	6		PL91D	6	
AH42	PL78A	6		PL92A	6	
AG42	PL78B	6		PL92B	6	
AG35	PL78C	6		PL92C	6	
AH35	PL78D	6		PL92D	6	
AG41	PL80A	6		PL94A	6	
AH41	PL80B	6		PL94B	6	
AG34	PL80C	6		PL94C	6	
AH34	PL80D	6		PL94D	6	
AJ42	PL81A	6		PL96A	6	
AK42	PL81B	6		PL96B	6	
AG33	PL81C	6		PL96C	6	
AH33	PL81D	6		PL96D	6	
AJ41	PL82A	6		PL98A	6	
AK41	PL82B	6		PL98B	6	
AJ37	PL82C	6		PL98C	6	
AK37	PL82D	6		PL98D	6	
AJ40	PL84A	6		PL99A	6	
AK40	PL84B	6		PL99B	6	
AJ34	PL84C	6		PL99C	6	
AK34	PL84D	6		PL99D	6	
AJ38	PL85A	6		PL103A	6	
AK38	PL85B	6		PL103B	6	
AH32	PL85C	6		PL103C	6	
AJ32	PL85D	6		PL103D	6	
AL42	PL86A	6		PL104A	6	
AM42	PL86B	6		PL104B	6	
AK36	PL86C	6		PL104C	6	
AL36	PL86D	6		PL104D	6	
AL38	PL89A	6		PL107A	6	
AM38	PL89B	6		PL107B	6	
AJ33	PL89C	6		PL107C	6	
AK33	PL89D	6	VREF2_6	PL107D	6	VREF2_6
AN42	PL90A	6		PL109A	6	
AP42	PL90B	6		PL109B	6	
AH31	PL90C	6		PL109C	6	
AJ31	PL90D	6		PL109D	6	
AN41	PL91A	6		PL112A	6	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AU9	PB103C	4		PB117C	4	
AU8	PB103D	4		PB117D	4	
AY8	PB104A	4		PB118A	4	
AY7	PB104B	4		PB118B	4	
AU7	PB104C	4		PB118C	4	
AU6	PB104D	4		PB118D	4	
BA7	PB105A	4		PB119A	4	
BA6	PB105B	4		PB119B	4	
AN13	PB105C	4		PB119C	4	
AN12	PB105D	4		PB119D	4	
AV9	PB107A	4		PB121A	4	
AV8	PB107B	4		PB121B	4	
AT10	PB107C	4		PB121C	4	
AT9	PB107D	4		PB121D	4	
AW8	PB108A	4		PB122A	4	
AW7	PB108B	4		PB122B	4	
AP11	PB108C	4		PB122C	4	
AP10	PB108D	4		PB122D	4	
BB5	PB109A	4		PB123A	4	
BB4	PB109B	4		PB123B	4	
AR10	PB109C	4		PB123C	4	
AR9	PB109D	4		PB123D	4	
BA5	PB111A	4		PB125A	4	
BA4	PB111B	4		PB125B	4	
AT7	PB111C	4		PB125C	4	
AT6	PB111D	4		PB125D	4	
BB3	PB112A	4		PB126A	4	
BA3	PB112B	4		PB126B	4	
AM14	PB112C	4		PB126C	4	
AL14	PB112D	4		PB126D	4	
AY5	PB113A	4		PB127A	4	
AY4	PB113B	4		PB127B	4	
AN11	PB113C	4		PB127C	4	
AN10	PB113D	4		PB127D	4	
AV7	PB115A	4		PB129A	4	
AV6	PB115B	4		PB129B	4	
AM12	PB115C	4		PB129C	4	
AM11	PB115D	4		PB129D	4	
AW5	PB116A	4		PB130A	4	
AW4	PB116B	4		PB130B	4	
AT5	PB116C	4		PB130C	4	
AT4	PB116D	4		PB130D	4	
AY2	PB117A	4		PB131A	4	
BA2	PB117B	4		PB131B	4	
AP9	PB117C	4		PB131C	4	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
B22	PT61B	1	A3/MPI_ADDR17	PT69B	1	A3/MPI_ADDR17
B23	PT61A	1	A4/MPI_ADDR18	PT69A	1	A4/MPI_ADDR18
K23	PT60D	1	D25/PCLKC1_5/MPI_DATA25	PT66D	1	D25/PCLKC1_5/MPI_DATA25
J23	PT60C	1	D26/PCLKT1_5/MPI_DATA26	PT66C	1	D26/PCLKT1_5/MPI_DATA26
D22	PT60B	1	A5/MPI_ADDR19	PT66B	1	A5/MPI_ADDR19
E22	PT60A	1	A6/MPI_ADDR20	PT66A	1	A6/MPI_ADDR20
K22	PT59D	1	D27/MPI_DATA27	PT63D	1	D27/MPI_DATA27
J22	PT59C	1	VREF1_1	PT63C	1	VREF1_1
D23	PT59B	1	A7/MPI_ADDR21	PT63B	1	A7/MPI_ADDR21
C23	PT59A	1	A8/MPI_ADDR22	PT63A	1	A8/MPI_ADDR22
L23	PT57D	1	D28/PCLKC1_6/MPI_DATA28	PT61D	1	D28/PCLKC1_6/MPI_DATA28
M23	PT57C	1	D29/PCLKT1_6/MPI_DATA29	PT61C	1	D29/PCLKT1_6/MPI_DATA29
A24	PT57B	1	A9/MPI_ADDR23	PT61B	1	A9/MPI_ADDR23
B24	PT57A	1	A10/MPI_ADDR24	PT61A	1	A10/MPI_ADDR24
K25	PT56D	1	D30/PCLKC1_7/MPI_DATA30	PT58D	1	D30/PCLKC1_7/MPI_DATA30
J25	PT56C	1	D31/PCLKT1_7/MPI_DATA31	PT58C	1	D31/PCLKT1_7/MPI_DATA31
F23	PT56B	1	A11/MPI_ADDR25	PT58B	1	A11/MPI_ADDR25
F22	PT56A	1	A12/MPI_ADDR26	PT58A	1	A12/MPI_ADDR26
J26	PT55D	1	D11/MPI_DATA11	PT57D	1	D11/MPI_DATA11
K26	PT55C	1	D12/MPI_DATA12	PT57C	1	D12/MPI_DATA12
E23	PT55B	1	A13/MPI_ADDR27	PT57B	1	A13/MPI_ADDR27
E24	PT55A	1	A14/MPI_ADDR28	PT57A	1	A14/MPI_ADDR28
G23	PT53D	1	A16/MPI_ADDR30	PT55D	1	A16/MPI_ADDR30
G24	PT53C	1	D13/MPI_DATA13	PT55C	1	D13/MPI_DATA13
F26	PT53B	1	A15/MPI_ADDR29	PT55B	1	A15/MPI_ADDR29
F27	PT53A	1	A17/MPI_ADDR31	PT55A	1	A17/MPI_ADDR31
H25	PT52D	1	A19/MPI_TSIZ1	PT54D	1	A19/MPI_TSIZ1
H24	PT52C	1	A20/MPI_BDIP	PT54C	1	A20/MPI_BDIP
C25	PT52B	1	A18/MPI_TSIZ0	PT54B	1	A18/MPI_TSIZ0
C26	PT52A	1	MPI_TEA	PT54A	1	MPI_TEA
K24	PT51D	1	D14/MPI_DATA14	PT51D	1	D14/MPI_DATA14
J24	PT51C	1	DP1/MPI_PAR1	PT51C	1	DP1/MPI_PAR1
F24	PT51B	1	A21/MPI_BURST	PT51B	1	A21/MPI_BURST
F25	PT51A	1	D15/MPI_DATA15	PT51A	1	D15/MPI_DATA15
L26	D_REFCLKP_L	-		D_REFCLKP_L	-	
M26	D_REFCLKN_L	-		D_REFCLKN_L	-	
G27	VCC12	-		VCC12	-	
C29	D_VDDIB3_L	-		D_VDDIB3_L	-	
F28	VCC12	-		VCC12	-	
D26	D_HDINP3_L	-	PCS 363 CH 3 IN P	D_HDINP3_L	-	PCS 363 CH 3 IN P
E26	D_HDINN3_L	-	PCS 363 CH 3 IN N	D_HDINN3_L	-	PCS 363 CH 3 IN N
B25	D_HDOUTP3_L	-	PCS 363 CH 3 OUT P	D_HDOUTP3_L	-	PCS 363 CH 3 OUT P
D24	VCC12	-		VCC12	-	
A25	D_HDOUTN3_L	-	PCS 363 CH 3 OUT N	D_HDOUTN3_L	-	PCS 363 CH 3 OUT N
E25	D_VDDOB3_L	-		D_VDDOB3_L	-	

Industrial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA40EP1-6FFN1020I[1]	-6	Lead-Free Organic fcBGA	1020	IND	40.4
LFSCM3GA40EP1-5FFN1020I[1]	-5	Lead-Free Organic fcBGA	1020	IND	40.4
LFSCM3GA40EP1-6FFAN1020I	-6	Lead-Free Organic fcBGA Revision 2	1020	IND	40.4
LFSCM3GA40EP1-5FFAN1020I	-5	Lead-Free Organic fcBGA Revision 2	1020	IND	40.4
LFSCM3GA40EP1-6FCN1152I[2]	-6	Lead-Free Ceramic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-5FCN1152I[2]	-5	Lead-Free Ceramic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	40.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.
2. Converted to organic flip-chip BGA package per PCN #01A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA80E-6FCN1152I[1]	-6	Lead-Free Ceramic fcBGA	1152	IND	80.1
LFSC3GA80E-5FCN1152I[1]	-5	Lead-Free Ceramic fcBGA	1152	IND	80.1
LFSC3GA80E-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	80.1
LFSC3GA80E-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	80.1
LFSC3GA80E-6FCN1704I[1]	-6	Lead-Free Ceramic fcBGA	1704	IND	80.1
LFSC3GA80E-5FCN1704I[1]	-5	Lead-Free Ceramic fcBGA	1704	IND	80.1
LFSC3GA80E-6FFN1704I	-6	Lead-Free Organic fcBGA	1704	IND	80.1
LFSC3GA80E-5FFN1704I	-5	Lead-Free Organic fcBGA	1704	IND	80.1

1. Converted to organic flip-chip BGA package per PCN #01A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA80EP1-6FCN1152I[1]	-6	Lead-Free Ceramic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-5FCN1152I[1]	-5	Lead-Free Ceramic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-6FCN1704I[1]	-6	Lead-Free Ceramic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-5FCN1704I[1]	-5	Lead-Free Ceramic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-6FFN1704I	-6	Lead-Free Organic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-5FFN1704I	-5	Lead-Free Organic fcBGA	1704	IND	80.1

1. Converted to organic flip-chip BGA package per PCN #01A-10.

Industrial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA115E-6FCN1152I[1]	-6	Lead-Free Ceramic fcBGA	1152	IND	115.2
LFSC3GA115E-5FCN1152I[1]	-5	Lead-Free Ceramic fcBGA	1152	IND	115.2
LFSC3GA115E-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	115.2
LFSC3GA115E-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	115.2
LFSC3GA115E-6FCN1704I[1]	-6	Lead-Free Ceramic fcBGA	1704	IND	115.2
LFSC3GA115E-5FCN1704I[1]	-5	Lead-Free Ceramic fcBGA	1704	IND	115.2
LFSC3GA115E-6FFN1704I	-6	Lead-Free Organic fcBGA	1704	IND	115.2
LFSC3GA115E-5FFN1704I	-5	Lead-Free Organic fcBGA	1704	IND	115.2

1. Converted to organic flip-chip BGA package per PCN #01A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA115EP1-6FCN1152I[1]	-6	Lead-Free Ceramic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-5FCN1152I[1]	-5	Lead-Free Ceramic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-6FCN1704I[1]	-6	Lead-Free Ceramic fcBGA	1704	IND	115.2
LFSCM3GA115EP1-5FCN1704I[1]	-5	Lead-Free Ceramic fcBGA	1704	IND	115.2
LFSCM3GA115EP1-6FFN1704I	-6	Lead-Free Organic fcBGA	1704	IND	115.2
LFSCM3GA115EP1-5FFN1704I	-5	Lead-Free Organic fcBGA	1704	IND	115.2

1. Converted to organic flip-chip BGA package per PCN #01A-10.